



Development of surface-plasma negative ions sources at BINP

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- **Surface-Plasma method and SPS features**
- **Negative Ion Sources, developed at BINP**
- **CW PIG sources for accelerators**
- **High-current RF sources for N-NBI**

Surface-Plasma method of Negative Ion production

Founded and formulated at BINP in 1971-1973.

Key investigators (PNNIB Proceedings 1977,1980) :

BINP (Dimov, Belchenko, Dudnikov)

BNL (Slyuters, Prelec)

LBL (Ehlers, Leung, Graham)

LLL (Hiskes)

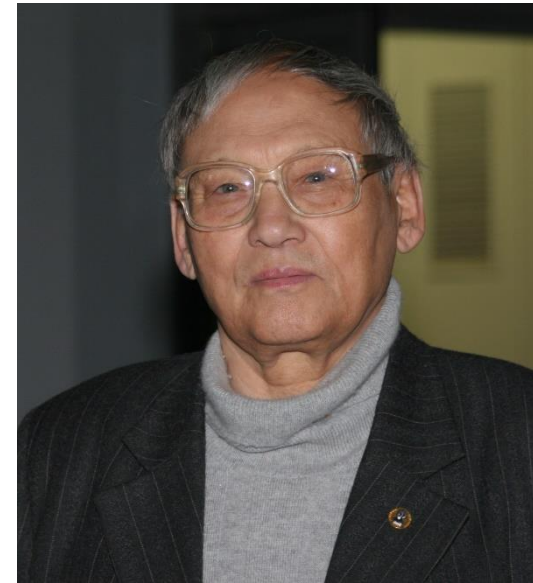
FNAL(Schmidt)

LANL (Allison)

ORNL (Stirling)

FOM (Los, Granneman, Hopman)

Universitat Bochum (Wiesemann)



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ORNL (Stirling, Tsai, Whealton)

Stevens Institute of Technology (Seidl, Melnichuk)

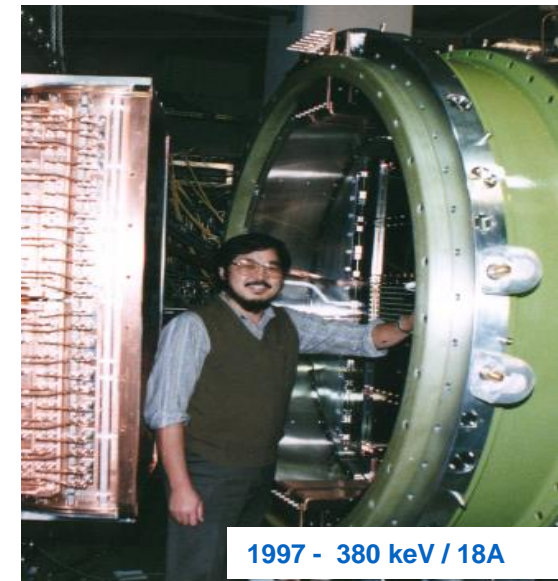
FOM (Los, Granneman, Hopman, van Bommel,
van Amersfoort, van Wunnik, Kleyn)

Universitat Bochum (Wiesemann)

KEK (Mori)

JAERI (Okumura, Hanada, Inoue)

NIFS (Kuroda, Kaneko, Oka, Ando, Takeiri)



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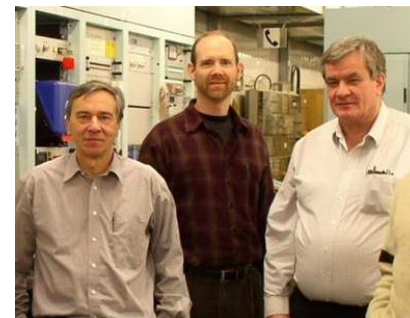
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ISIS, J-PARK, SNS, IPP, Padova,...

to be continued

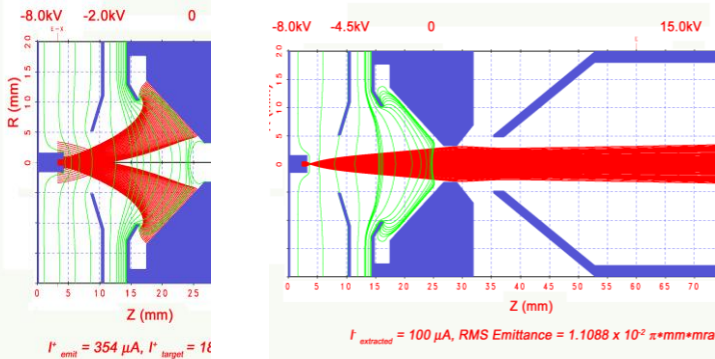


Principles of Surface-Plasma Sources

1. Intense bombardment of electrodes by energetic plasma particles
2. Surface conversion of incident H_i^+ , H_0 to ions H^- due to kinetic emission
3. Post-acceleration of surface-produced H^- ions by near-electrode potential drop
4. Decrease of surface work function to increase the NI kinetic emission
5. Self-organization of plasma structure and surface layer to support NI emission

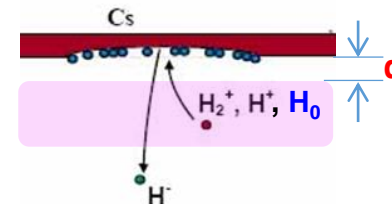
C^- sputter sources (Middleton)

Cs^+ flux to target 0.2 mA (10 mA/cm², 8 kV)
 C^- flux emitted 0,1 mA (1 mA/cm², 23 kV)



Surface-Plasma sources (magnetron)

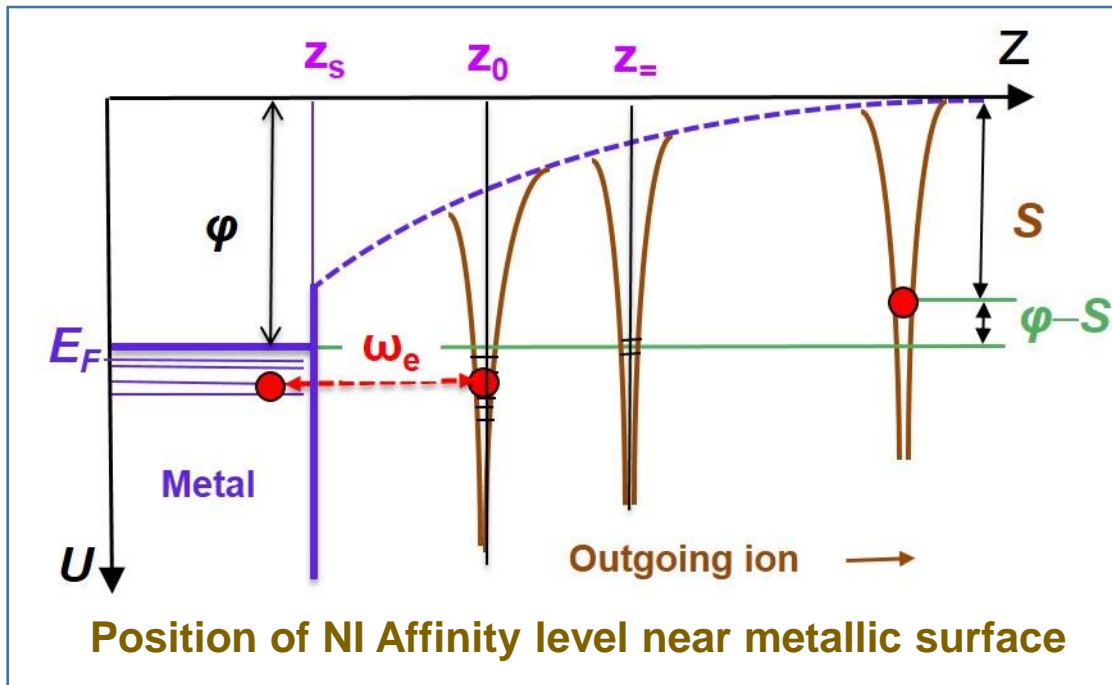
Positive ions flux to cathode 50 A (10 A/cm², 70 V)
 H^- ions emission current 0,3 A (3 A/cm², 100 V)



An intense bombardment of electrodes by energetic ions and atoms is provided by plasma through narrow self-adjusted sheath ($d \sim 10^{-2}$ mm)

Kinetic (nonequilibrium) NI emission

M. Kishinevsky (BINP), J. Hiskes (LLL) , B.Rasser (FOM)



Electronic exchange rate ω_e decreases exponentially vs distance z :

$$\omega_e = \omega_0 \exp(-z/\lambda)$$

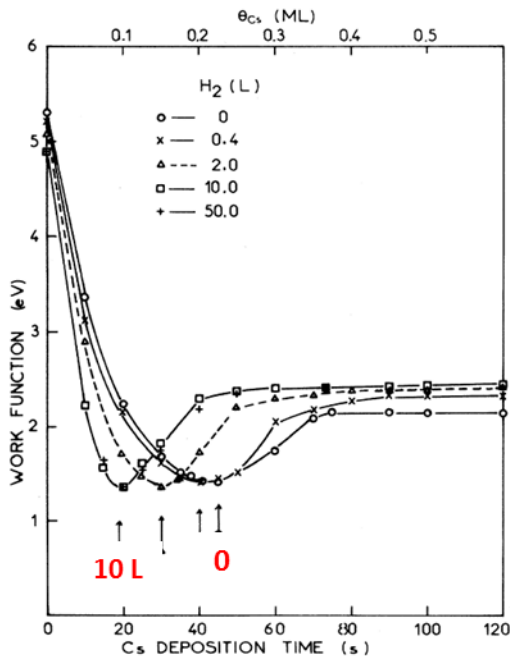
It favors the outgoing NI survival

- Negative ion overcomes the surface barrier $\phi - S$ due to initial kinetic energy
- Outgoing atom should pick-up an electron in the close zone $Z_- - Z_s$
- Outgoing Negative ion should be fast in the zone $Z > Z_-$ to keep an extra electron
- Probability to lose electron in the zone $Z > Z_-$ $P_{-0} \sim \int_{z_-}^{\infty} \omega_e dt \cong \omega_- \cdot \frac{\lambda}{v_{\perp}}$

For H^- ion near $W+Cs$ surface: $\lambda \sim 2a_0$, $\omega_- \sim 7 \cdot 10^{13} \text{ s}^{-1}$, $P_{-0} < 0,3$ at $v_{\perp} > \sqrt{2,5 \text{ eV}}$

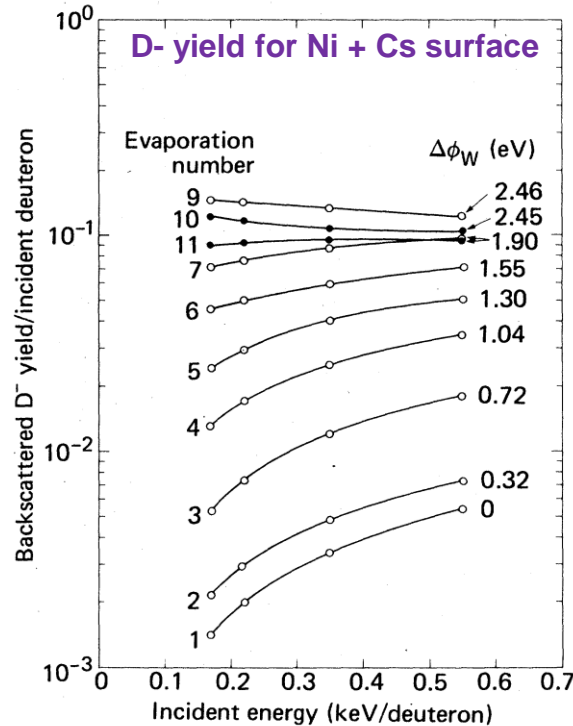
Effect of Cesium on Kinetic NI emission

In principal, there is no need for cesium in Kinetic NI emission



Cs deposition decreases the surface work function

for pure metal and for surface with co-adsorbed Hydrogen



Cs deposition increases NI emission ~10÷100 times

(Schneider et al, 1981)

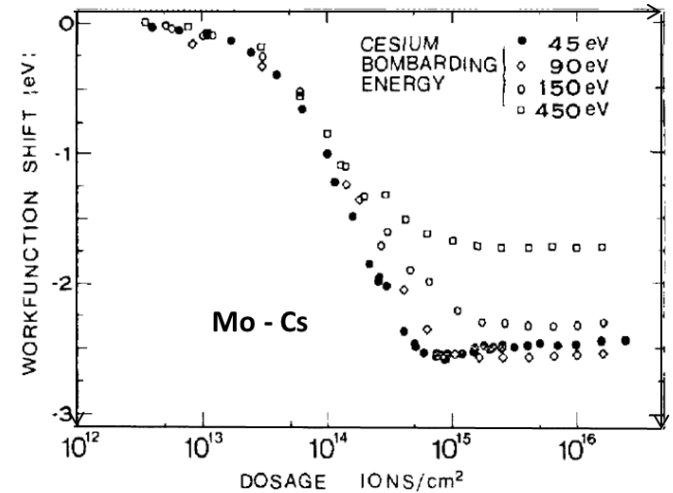
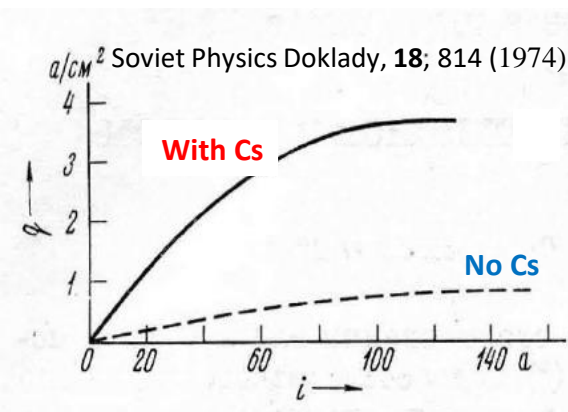


FIG. 1. Work-function shift as a function of the positive cesium ion dosage.

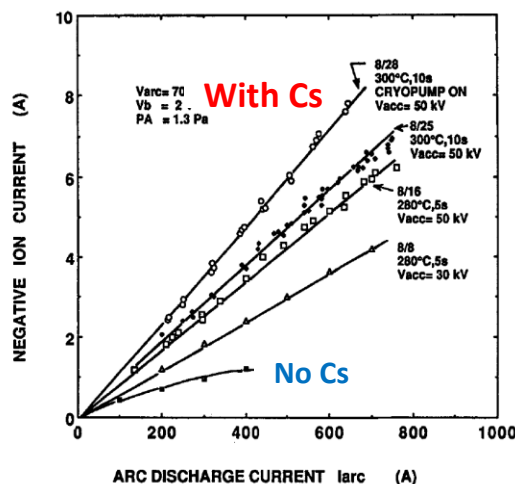
Bombardment by low energy Cs⁺ ions (45 eV) provides the similar decrease of work function. (No solid Cs film produced - Cs implantation?)

Triple Effect of Cesium in the SPS

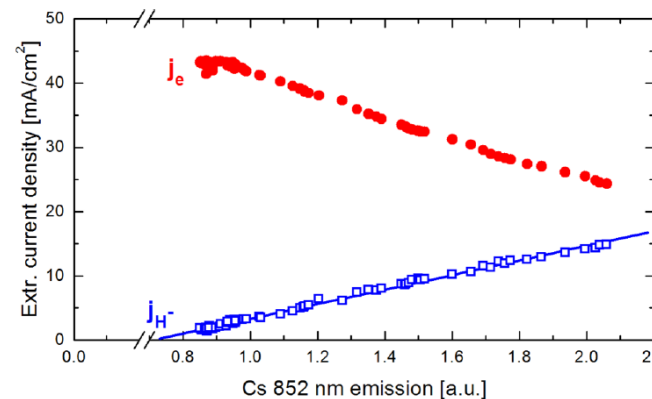
1. **Enhancement of H⁻ production.** Pulsed magnetron – NI emission current density up to 4 A/cm²
2. **Co-extracted electrons suppression** Ratio e: H⁻ < 1
3. **Decrease of Operation hydrogen filling pressure** (arc and RF SPSs - down to 0,3 Pa)



Magnetron SPS
(BINP, 1974)



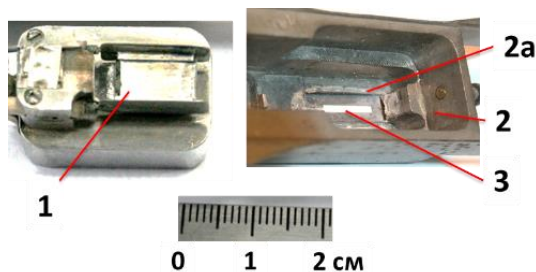
Multi-Ampere SPS
(JAERI, 1990)



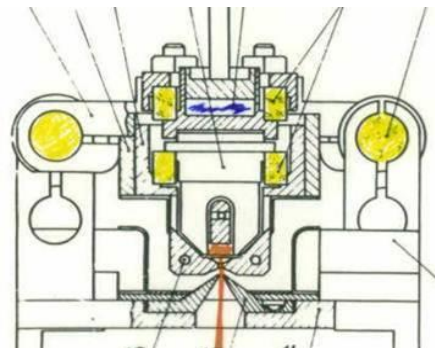
RF source BATMAN
(IPP, 2016)

**Stable optimal Cs coverage on SPS emitters could be provided
Cesium seed does not prevent the IOS high voltage holding**

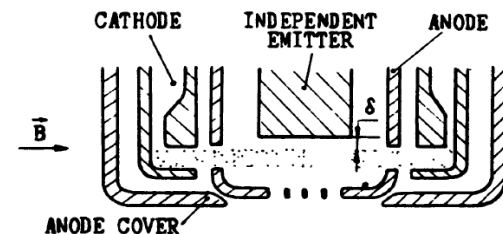
Variety of Experimental H- Ion Sources developed at Budker Institute



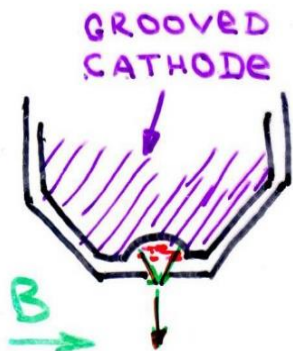
Magnetron (planotron) 1971



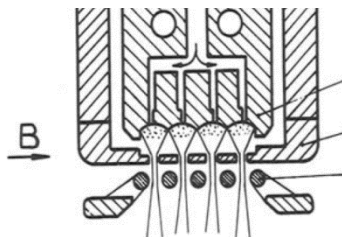
With PIG discharge 1973



with converter and hollow cathodes PIG 1977



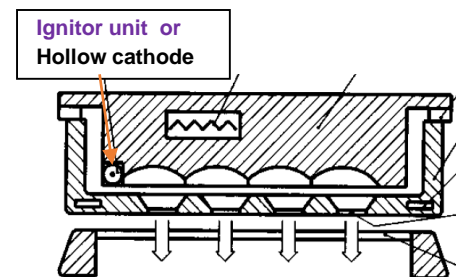
with unclosed $E \times B$ drift and geometrical focusing 1978



Multislit Semiplanotron with geometrical focusing 1980

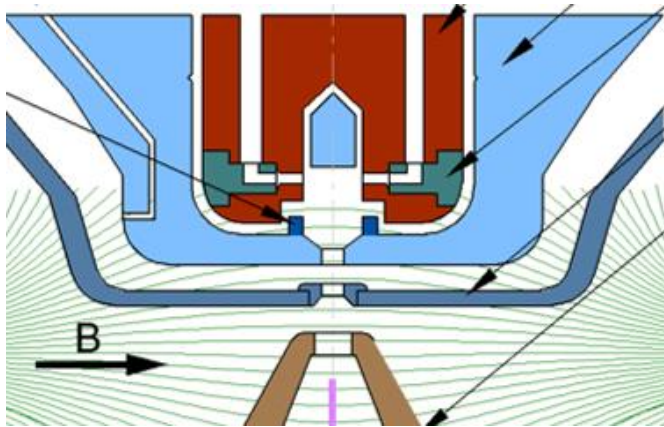


Honeycomb Source with 2D geometrical focusing 1982



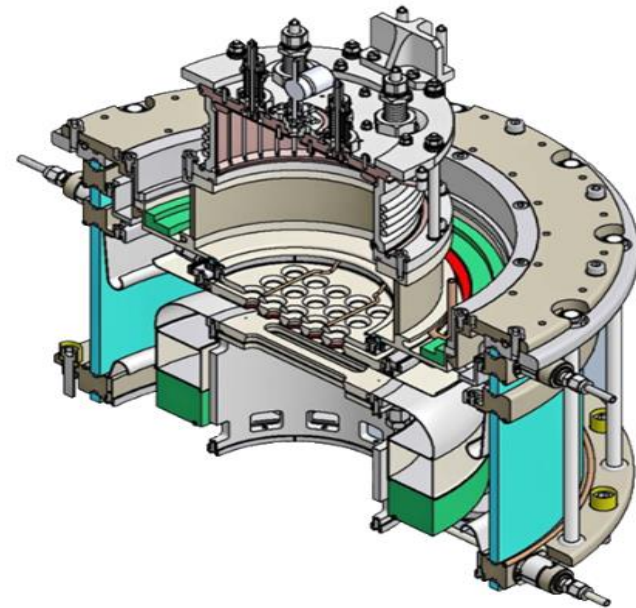
Large Honeycomb Source with additional ignitor 1988 with hollow cathodes 1998

Negative Ion Sources developed at Budker Institute in last decade



**CW Penning source with hollow cathodes
for tandem accelerator**

2002 - ...



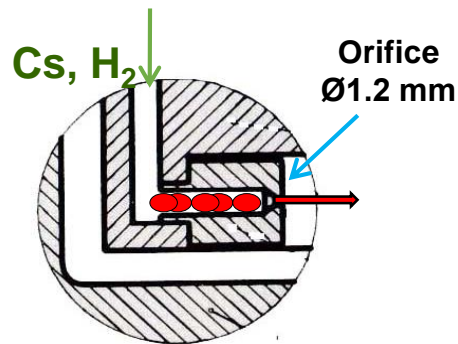
**Inductive long-pulsed RF source
with directed Cs seed and IOS temperature
control**

2012 -

Development of CW sources for tandem accelerator

The development of CW Source with Penning geometry and hollow cathodes was started in 1993. The first flange source version was studied since 2002, and it installed to BINP tandem in 2006

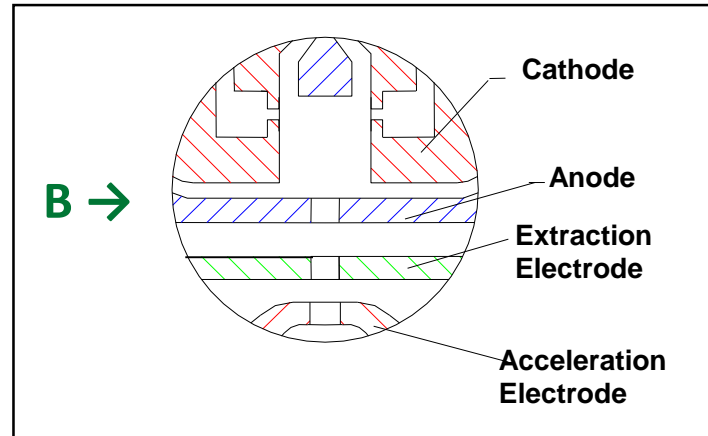
Effect of "orificed" hollow cathode



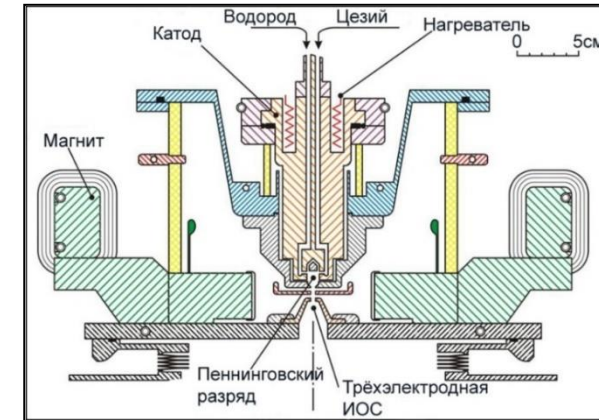
Plasma injection from Hollow cathodes supports PIG discharge under low H₂ pressure ~30 mTor

Discharge is localized near emission zone

Long cathode life time (Mo redeposits inside HC)



Principal Scheme



First version of CW Source for BINP tandem

- Penning discharge
- "Orificed" hollow cathode inserts
- Dipole magnetic field in discharge and IOS
- Triode IOS with circular apertures
- H⁻ ions production on the cesiated anode
- CW cesium feed ~ 5 mg/h from cesium pellets to support hollow cathode PIG discharge and to enhance H⁻ yield

CW Source for tandem and its parts



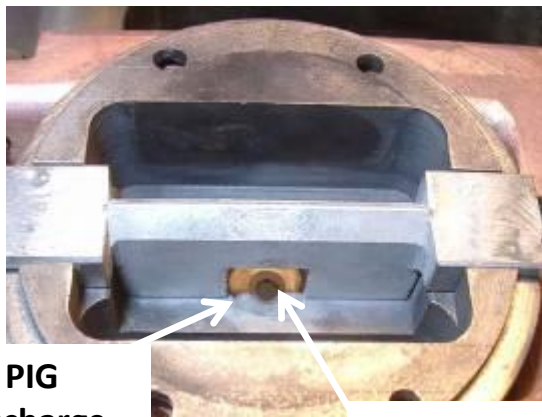
Source assembly



Cathode



Anode body with emission aperture



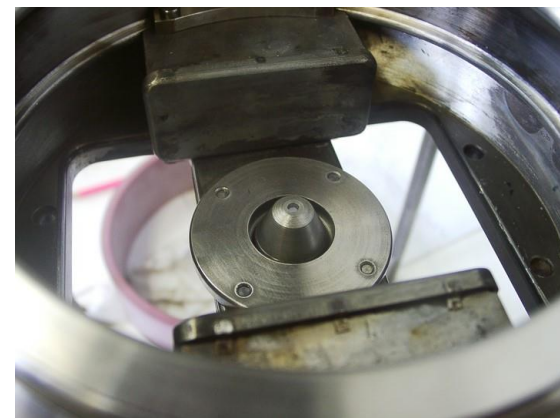
PIG discharge Area

Emission aperture

Anode assembly

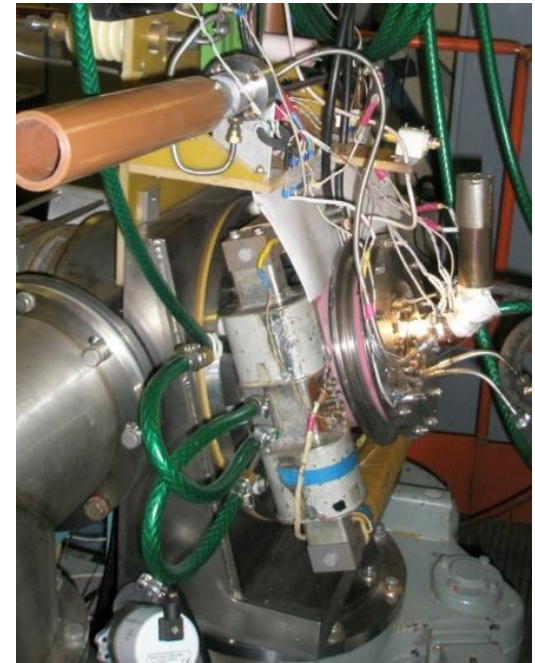
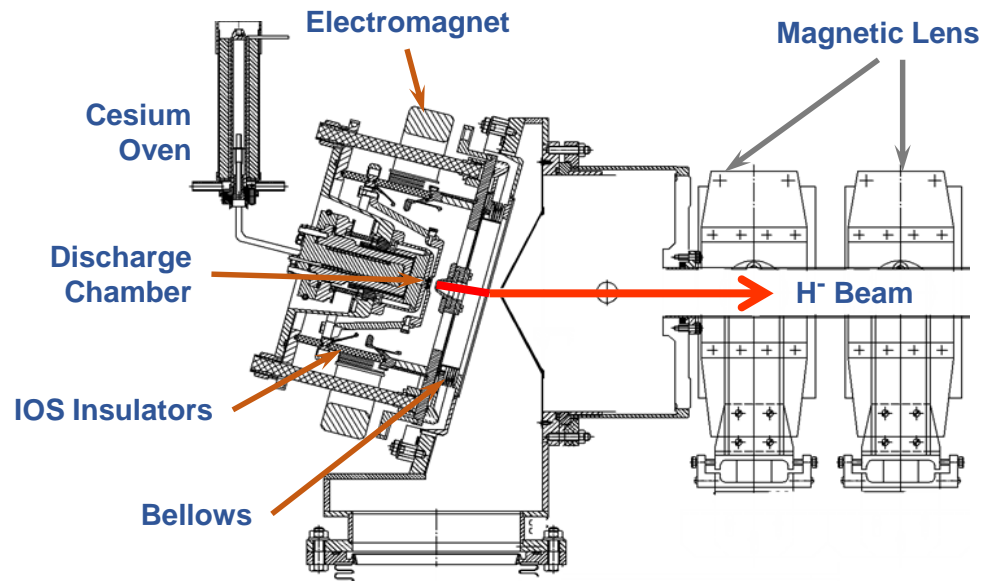


Extraction Electrode



Acceleration Electrode and magnetic poles

Source works at BNCT experimental tandem



Installed to the tandem LEBT in 2006 and is operated for more than 10 years

Source view

PIG Discharge	80 V / 10 A
Magnetic field	0.6 kGs
Hydrogen pressure	30 mTor
Cesium feed	< 5 mg/h

H- beam current	1-8 mA
Emission aperture	3 mm
Extraction	1-3 kV/30 mA
Post-acceleration	20 kV/40 mA

Starting time	50 min
Electrode conditioning time	< 10 min
Uninterrupted runs	4 ÷ 6 h/day

Typical parameters of the source work at BNCT experimental tandem

The CW source Electrodes Erosion and Wear



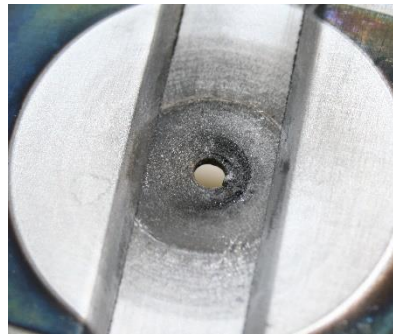
Cathode erosion after 12 month work



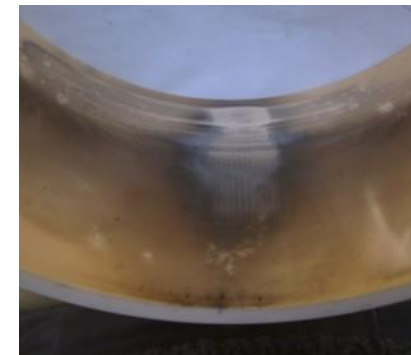
Moly film deposition to anode cover after 160 hours run



Accelerated Electrode melting by electrons



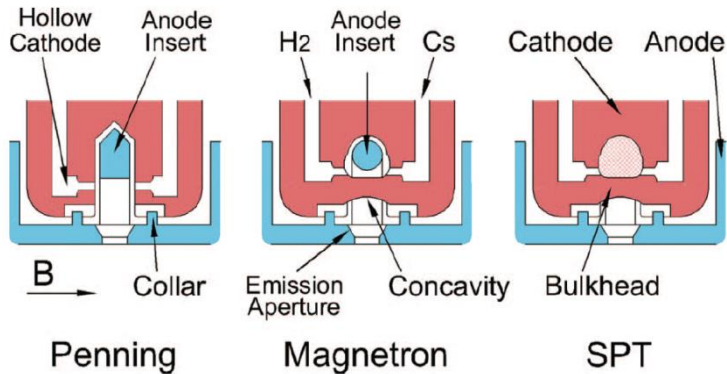
Extracted electrode aperture melting by electrons after 6 month work



IOS ceramics erosion by electrons after 6 month work

CW Sources with Hollow cathodes Magnetron and Semiplanotron geometry

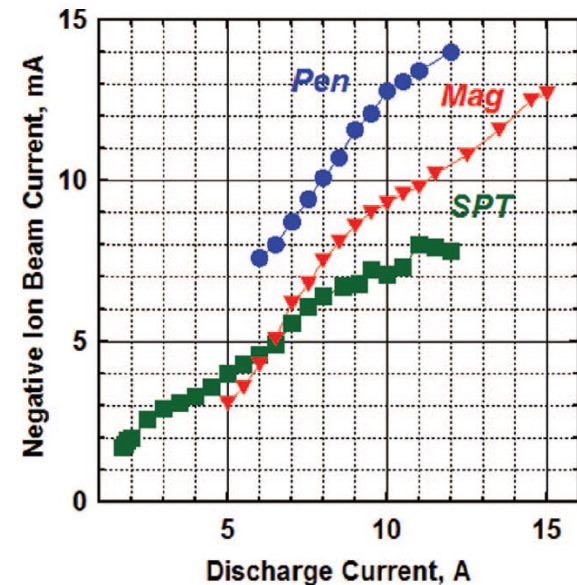
Magnetron and Semiplanotron CW Sources with hollow cathodes were manufactured to check their capabilities CW negative ion beam production



The basic CW Penning source was modified by introducing the solid central bulkhead between the cathode protrusions



Magnetron source cathode with bulkhead and spherical concavity on the bulkhead plane

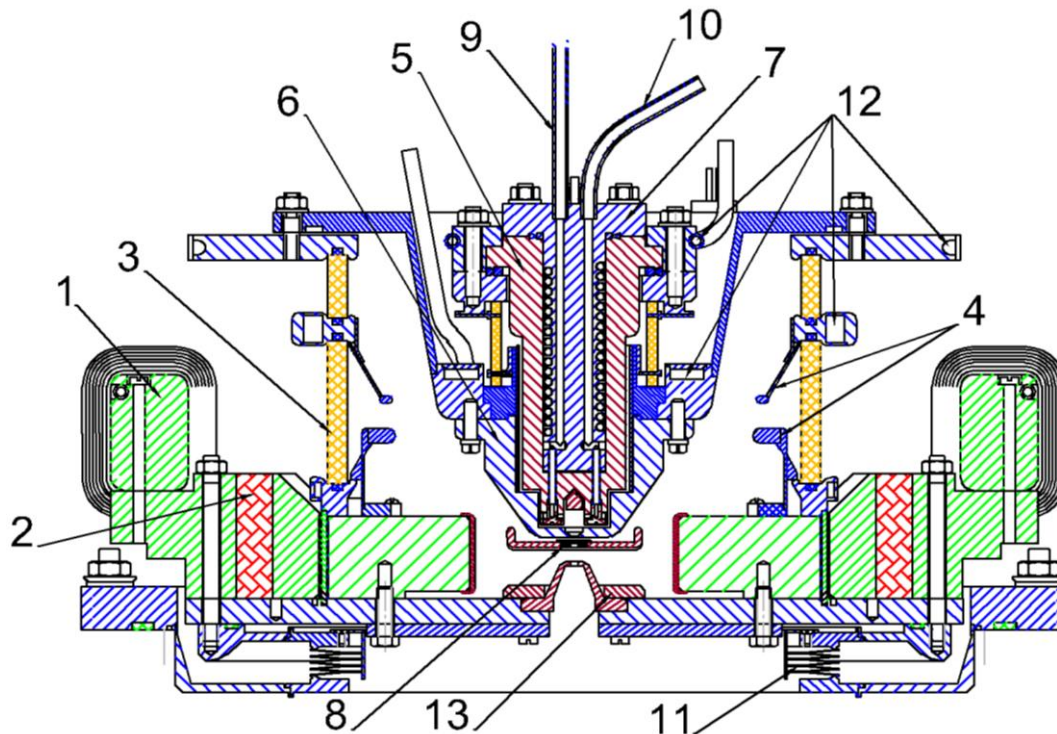


H⁻ beam current vs discharge current for Penning, magnetron and semiplanotron source.

~ 50% of H⁻ beam, extracted from magnetron is the cathode-produced one (emission aperture \varnothing 1.5 mm)

Lower H⁻ beam production in the CW magnetron and semiplanotron – due to impeded cesium redistribution to the cathode emission area.

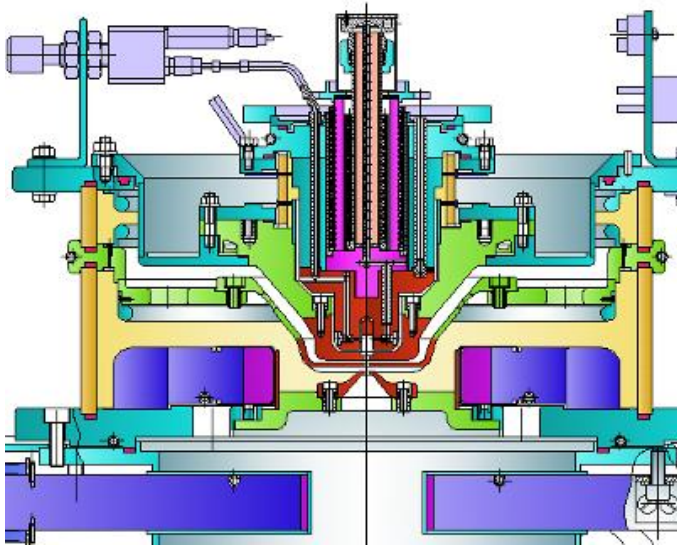
Modification of CW Negative Ion Source for tandem accelerator



Several modifications of Penning source were applied to increase the H-current and reliability, and to decrease the electrodes and ceramics erosion

Reported by A.Sanin in talk WedO6 “Operating Experience and Recent Updates of Negative Hydrogen Ion Source at BINP Tandem Accelerator”

15 mA CW Negative Ion Source



The similar principal scheme



Magnets with yoke are placed inside HV ceramics



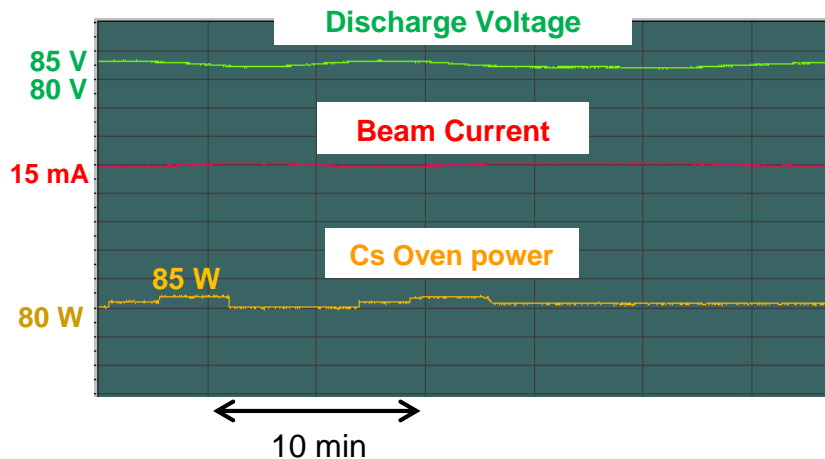
Collar around the emission aperture at the anode cover

- Replaceable Insulators
- Replaceable heaters of the cathode and of the Cs oven
- Permanent NdFeB Magnets
- Additional “correlation” magnet system
- Temperature control of electrodes with thermal spacers
- Controlled Air cooling of Cs system coldest point

At the stand

H- beam current	15 mA
Emission current density	150 mA/cm ²
Emission aperture	3.5 mm
Extraction Voltage/current	5-8 kV/30 mA
Acceleration Voltage /current	28 kV/40 mA

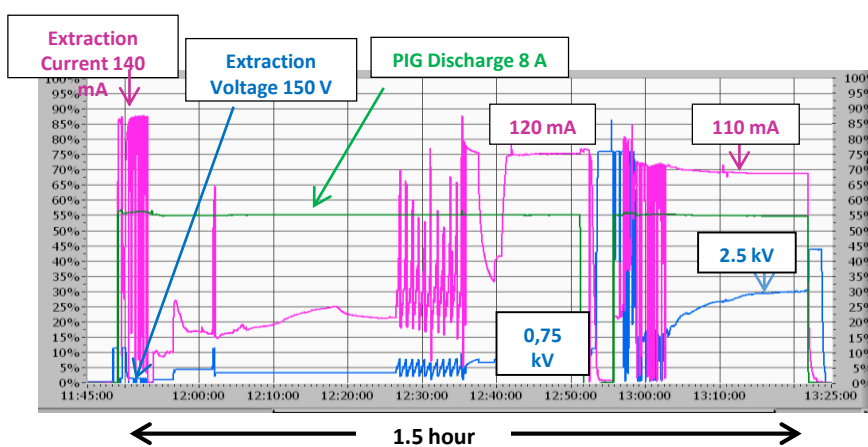
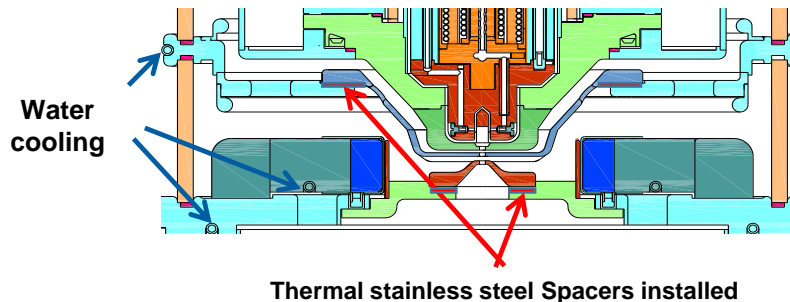
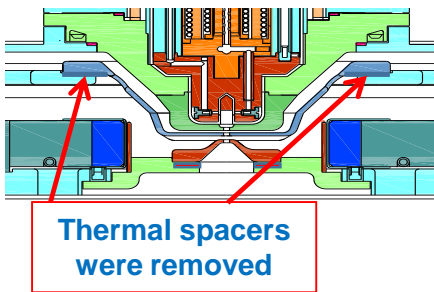
Several >100 hours run were successfully approved



PIG Discharge Voltage and H- Beam response to Cs seed change

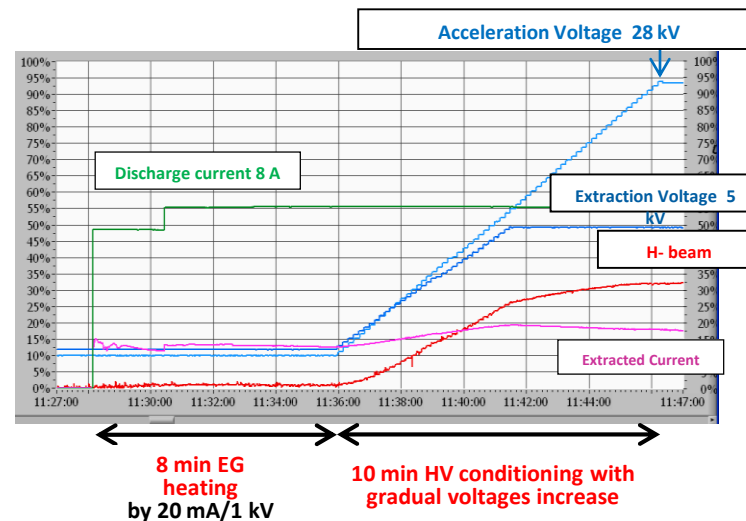
Importance to keep the Extraction Electrode hot

Special Thermal Spacers, installed between flanges and IOS electrodes make the electrode tips hot and improve the source conditioning!



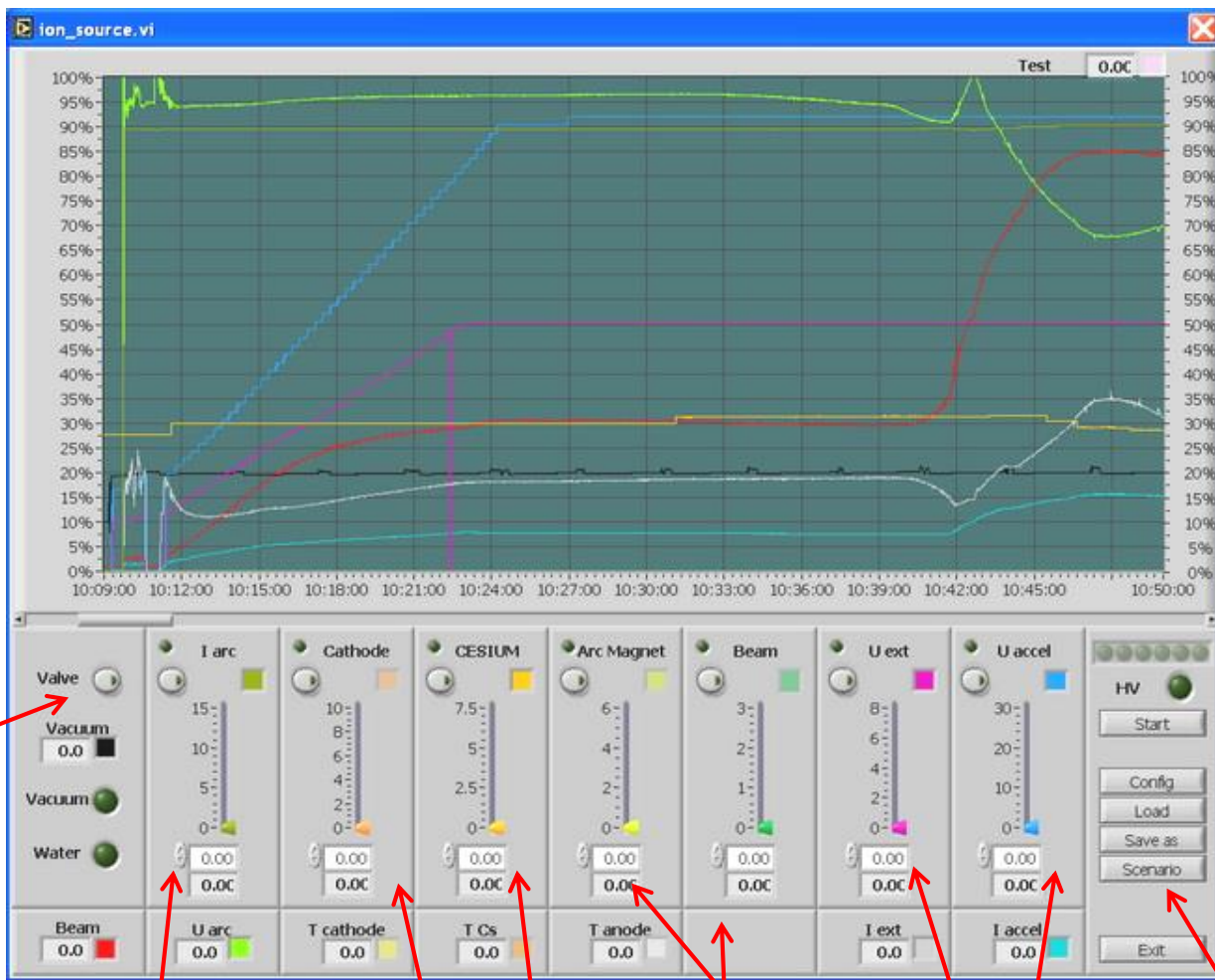
Cold Extraction Electrode

Unlucky attempts to heat and to condition EE.
Arcing and dc glow in the extraction gap



Extraction Electrode with poor cooling
Fast IOS conditioning at the source start

Source Control by Autopilot



Hydrogen feed

Beam Current

Discharge

Heater

Cs

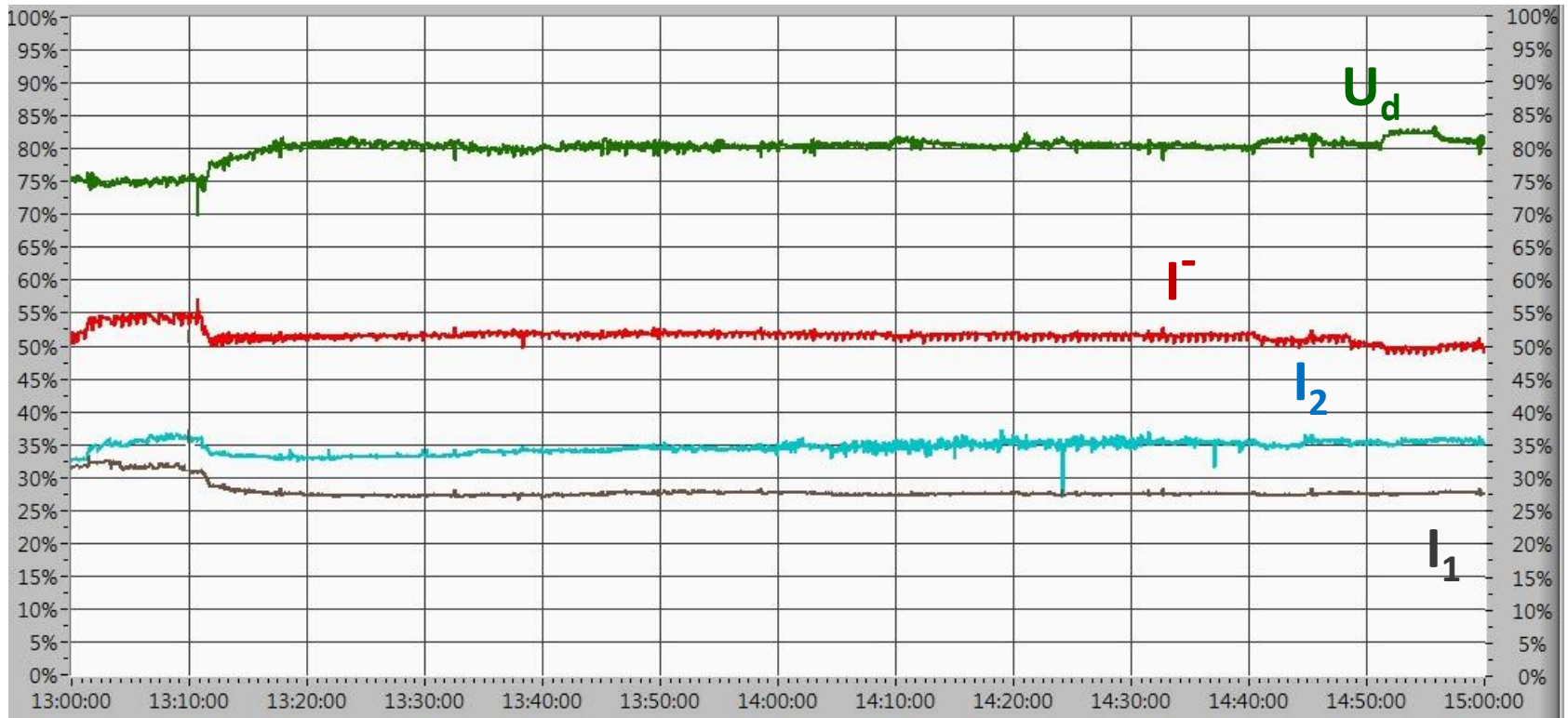
Magnets

HV PSs, kV/mA

Scenario

15 parameters are monitored

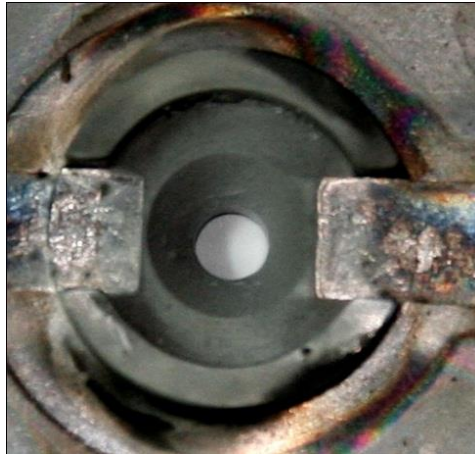
Long Term Runs with 25 mA Beam Production



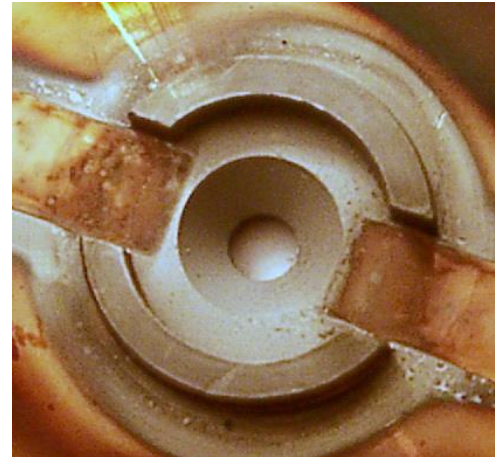
Tracks of 2-hours source run with formation of **25 mA** beam.
Red - beam current $I^- = 25\text{mA}$ (100%=50mA), green - discharge voltage $U_d = 80\text{V}$ (100%=100V),
brown - extraction electrode current $I_1 = 55\text{mA}$ (100%=200mA); Blue - acceleration electrode
current $I_2 = 70\text{mA}$ (100%=200mA). Horizontal scale is 10 min per division.

Cesium Coverage on the Anode

- A sizeable deposition of sputtered molybdenum to the emission surface around the emission aperture was revealed in the CW Penning source.
- The dynamic Cs coverage on the anode **tolerates the overlaying by molybdenum**. The thick Cs-Mo film with low work function could be deposited on the anode by co-adsorption of the cesium and molybdenum fluxes.

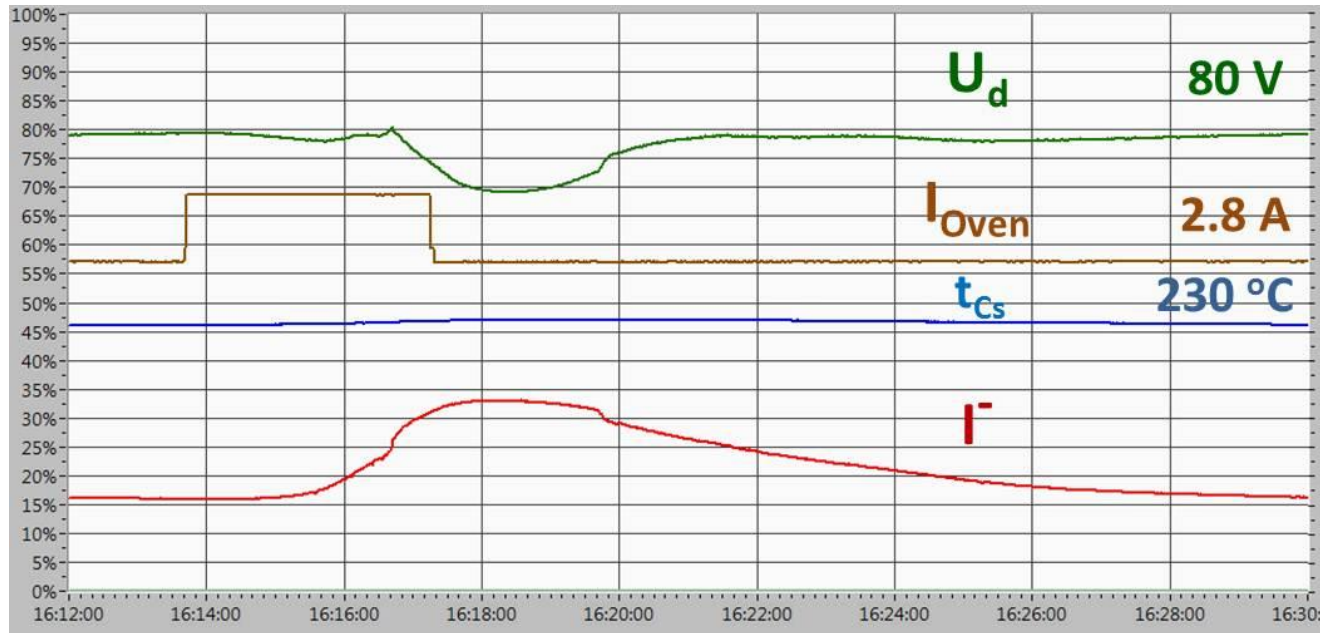


Sputtered molybdenum on the Molybdenum anode cover



Sputtered molybdenum on the Copper anode cover

Source Response to Cesium Seed Change

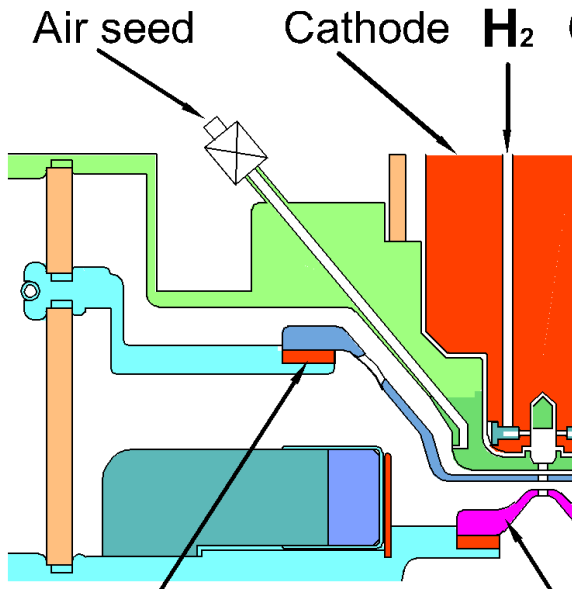


Oven heater current was increased for 3 minutes

I^- - beam current, U_d - discharge voltage, I_{Oven} - oven heating current; t_{Cs} - cesium cold point temperature.
time scale 2 min per division.

- ❑ Beam current and discharge voltage are sensitive to Cs seed change
- ❑ Gradual 10 min decrease of beam current was recorded after oven power decrease due to anode cesium coverage overlaying by sputtered molybdenum.

Air Seed to the Extraction Gap



	Before Air deposition	During Air deposition	After Air deposition
Beam Current, mA	14.7	14,0	14.7
Extraction current, mA	34	26	36
Acceleration current, mA	25	22	22
Discharge voltage, V	76	79	78

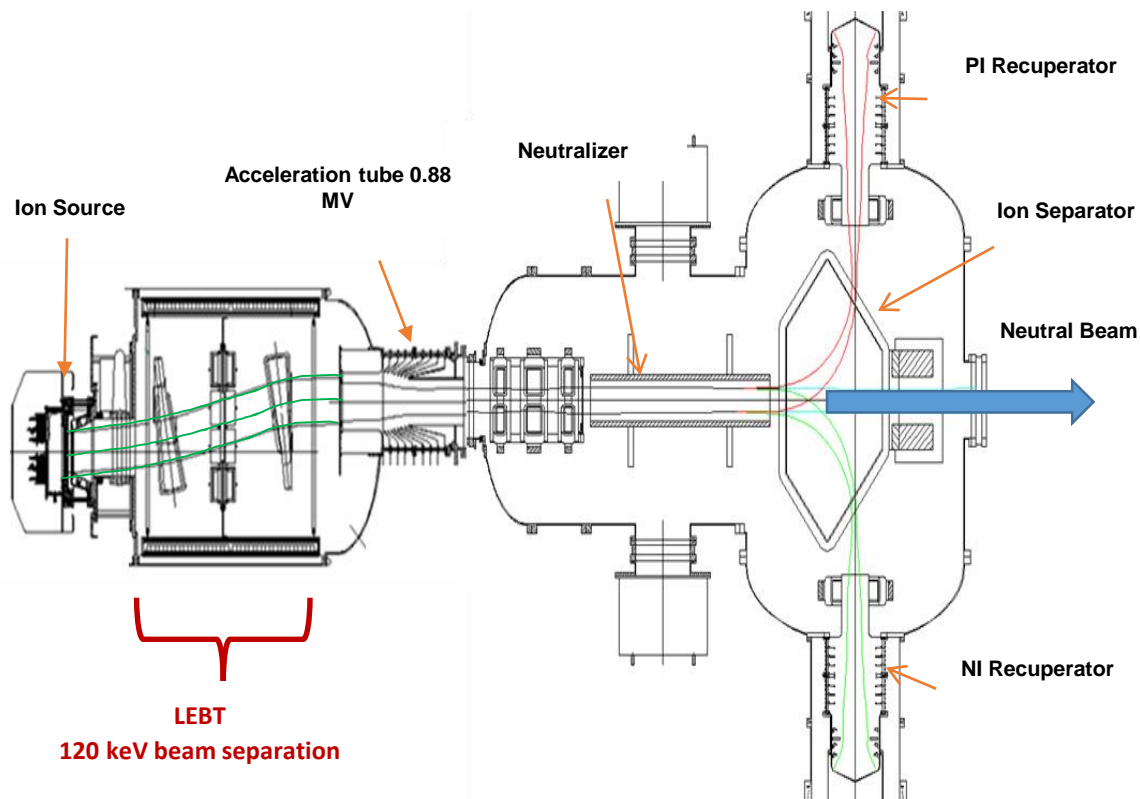
An attempt to passivate cesium coverage on the IOS electrodes by controlled injection of air to the extraction gap was performed.

An air flow up to $5 \cdot 10^{-3}$ L-Tor/s (~5% of H₂ feed) was seeded to the extraction gap

Dynamic Cs coverage on the anode is resistant to residual air leak

BINP work on Negative Ion Based NBI

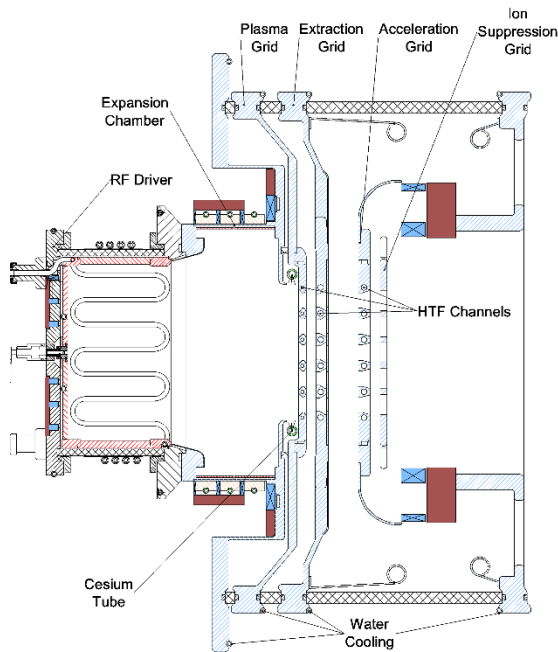
Principal Scheme of BINP 1MeV Negative Ion Based Neutral Beam Injector



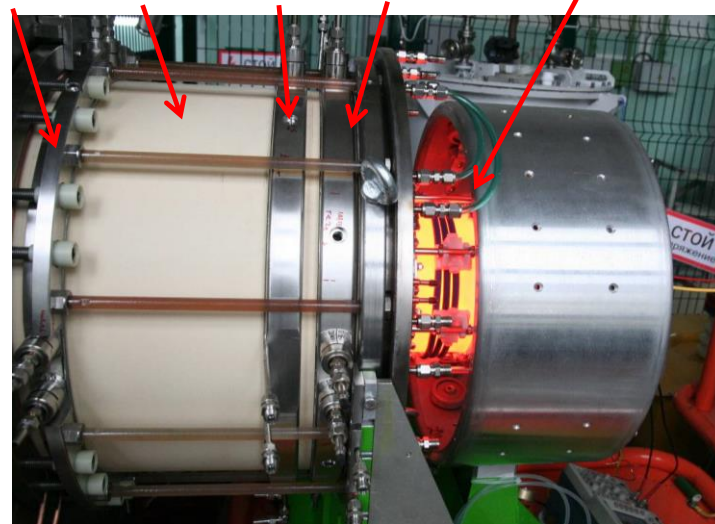
Beam acceleration is produced after purifying from the co-streaming fluxes of primary and secondary particles (gas, fast neutrals, electrons, cesium, light)

Negative ion beam is focused to a single-aperture 0.5-1 MeV accelerating tube. The stresses of the accelerator must be considerably reduced.

Inductive RF source with Surface-Plasma Negative Ions production



AG Ceramic 110 kV EG PG RF Driver



What's new

Standard features

Negative Ion production on the cesiated PG surface (Surface-Plasma Source)

Plasma produced by RF driver Electrons are filtered by magnet filter

Positive Bias of plasma grid to suppress electrons extraction

Multiperture 3-4-grids IOSs

Keeping the driver walls, the extraction and plasma grids hot during cesium operation.

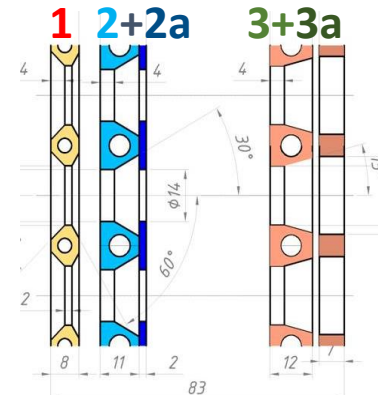
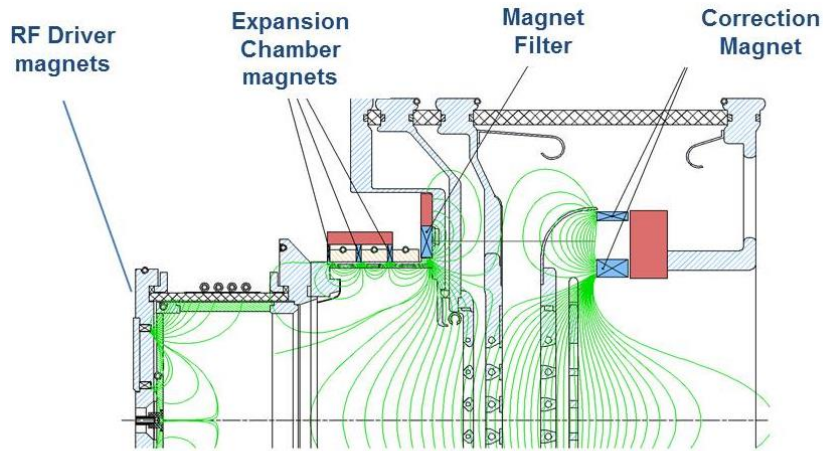
IOS electrodes heating and cooling by circulation of heat transfer fluid (Marlotherm)

Directed distributed cesium deposition to plasma grid via the long distribution tubes, attached to PG

Additional magnets to concave the field in the extraction gap

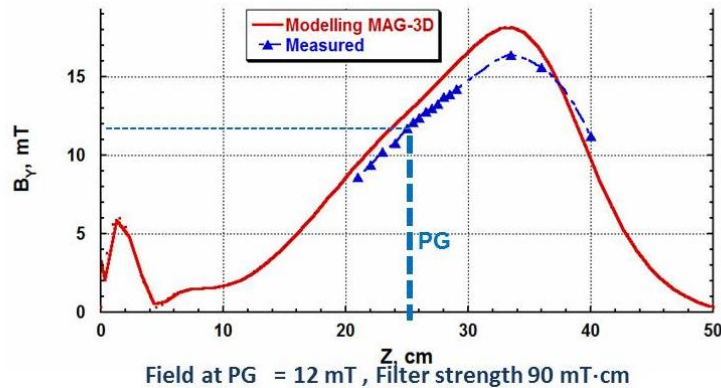
External NIB magnets. No magnets immersed into the hot grids.

Magnet and Ion Optical Systems



IOS cells geometry

- 1 - Plasma Grid, 2 - Extraction Grid
- 2a - Electron Suppression Grid
- 3 - Acceleration Grid
- 3a - Positive Ion Suppression Grid

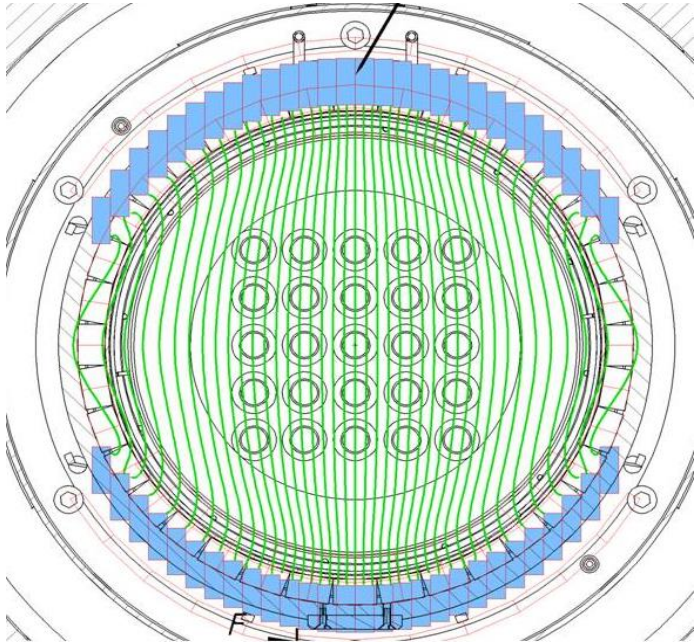


Magnet positions and magnetic field distribution along the source axis

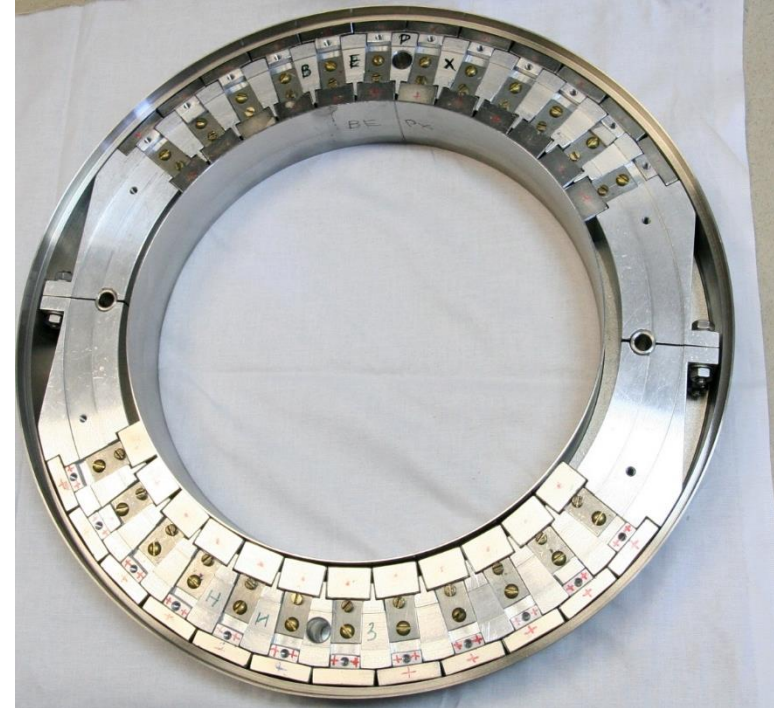
Apertures Diameter, mm	16
Horizontal Pitch, mm	27
Vertical Pitch, mm	27
Aperture Area, cm ²	2
Emission Zone Area, cm	13x13
Extraction gap, mm	6
Acceleration gap, mm	47

Dipole magnetic filter

NIB filter magnets



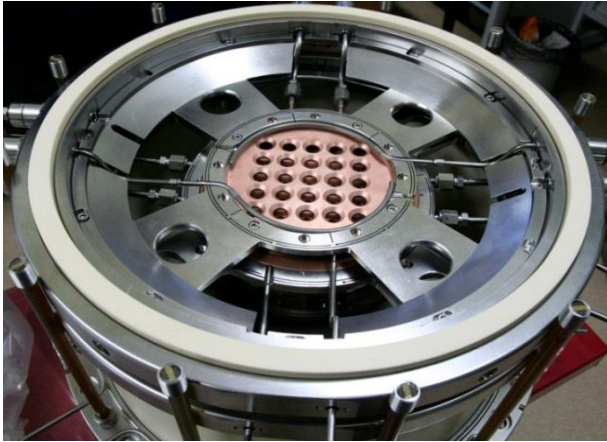
PG magnet filter



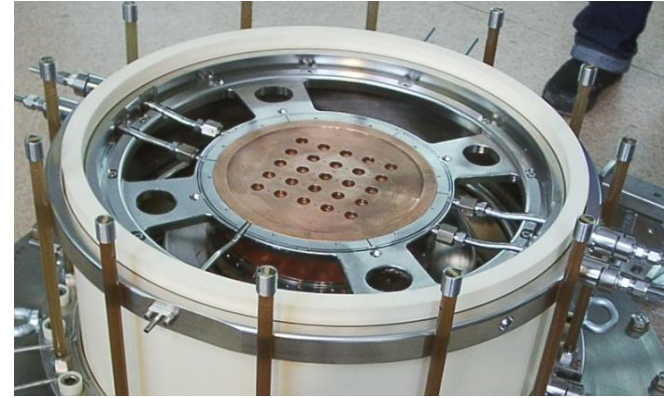
Correlation dipole magnet at AG base

Magnetic field was calculated by 3D code MAGEL3D (M.Tiunov, BINP)

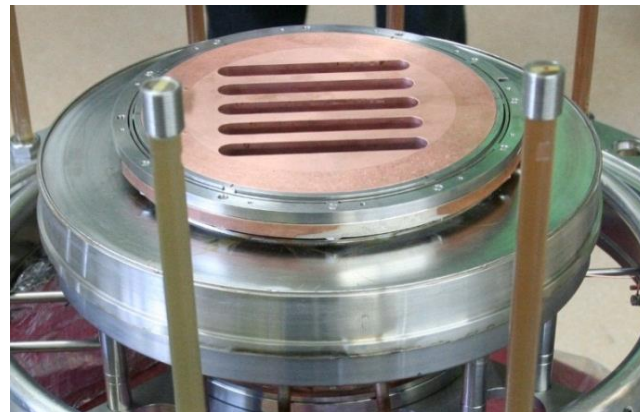
Ion Optical System Grids



Plasma Grid
with 25 emission apertures



Extraction Grid
with 25 apertures



Acceleration Grid with 5 slits

Distributed Cesium Seed

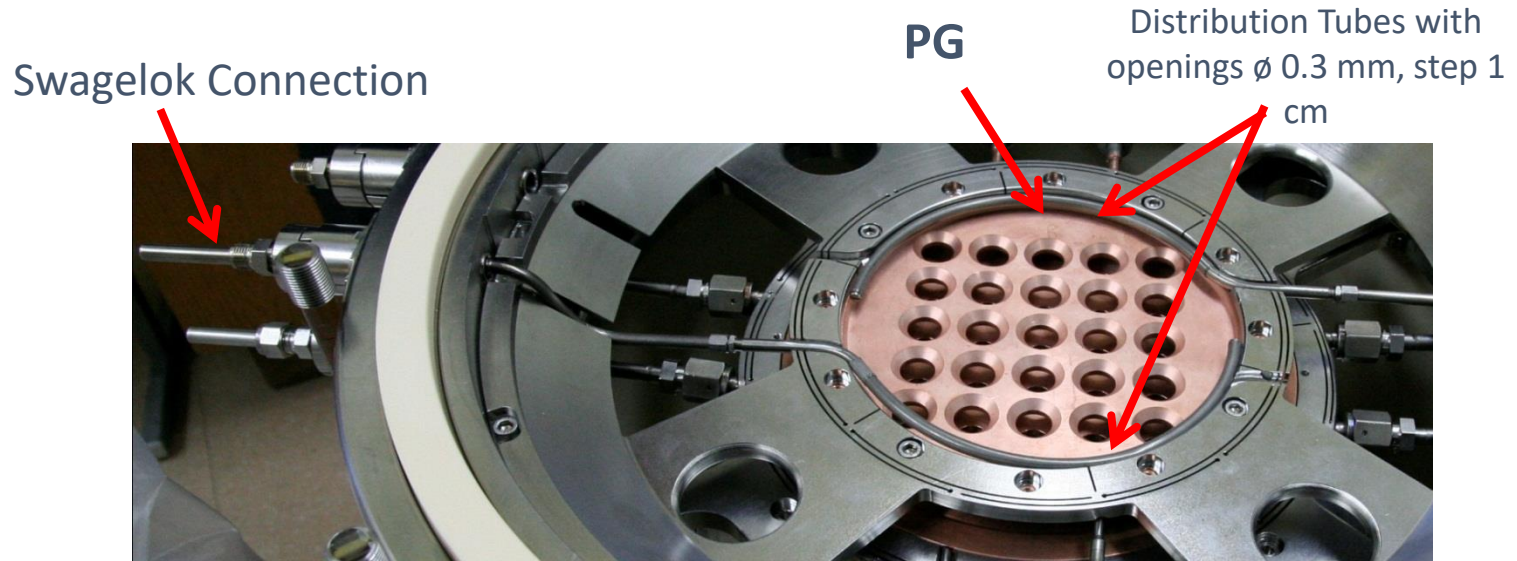
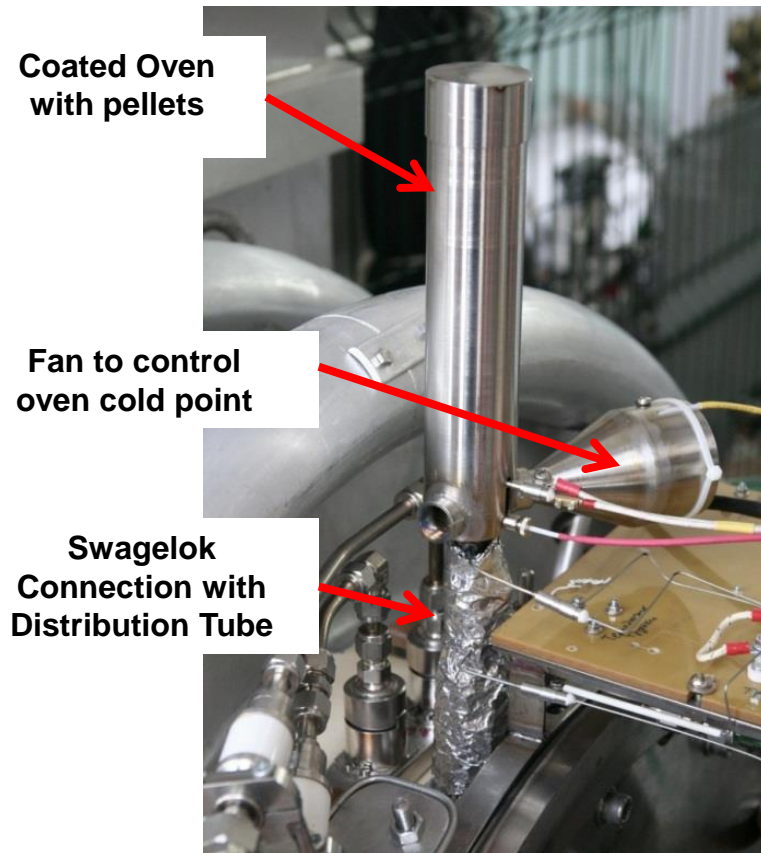


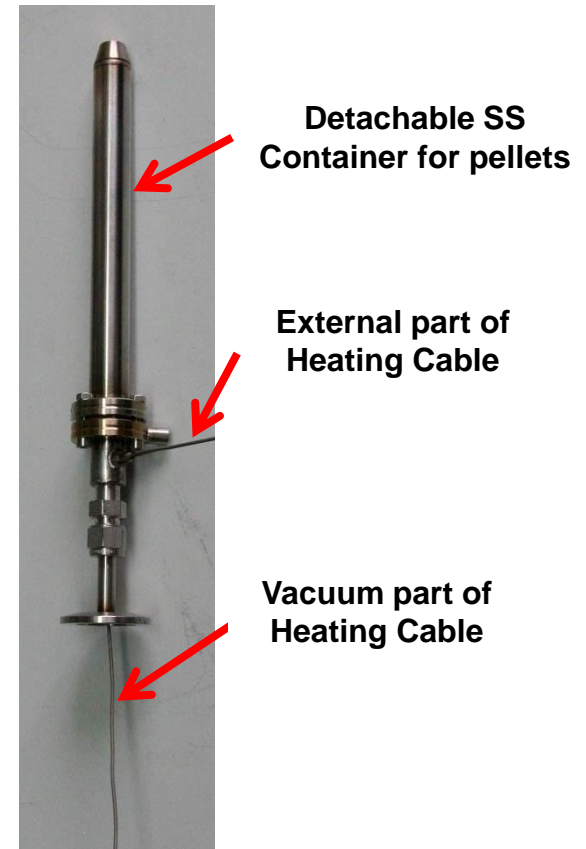
Photo of Plasma Electrode with Cesium Distribution Tubes

- Distribution tubes have \varnothing 0.3 mm openings, drilled with 10 mm pitch. Tubes are heated to ~ 250 °C by internal thermocable.
- Two types of Cs systems were developed and studied at separate stand:
 - with metallic cesium and valves
 - with cesium-chromate + titanium pellets
- Cesium redistributes over PG plane by thermal desorption and sputtering too

Cs ovens with cesium-chromate pellets



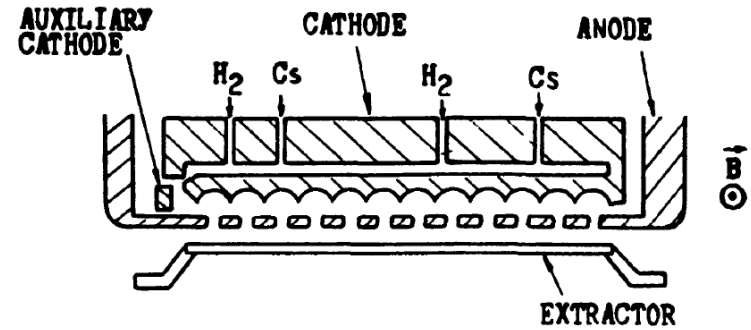
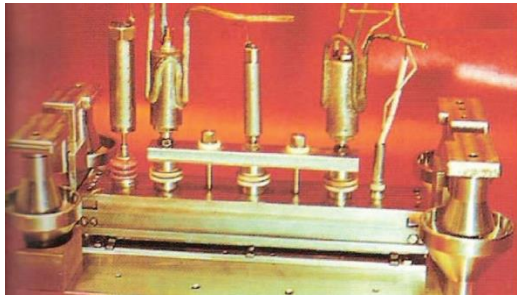
Cs Oven System at the PG flange



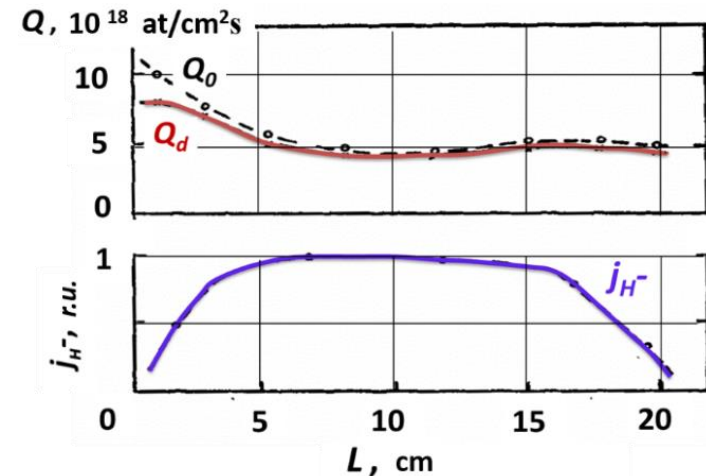
Cs Oven (coat and oven heater detached) before connection to PG flange

Cesium Redistribution by discharge

Cathode area 3 x 20 cm² BINP, 1982 г.



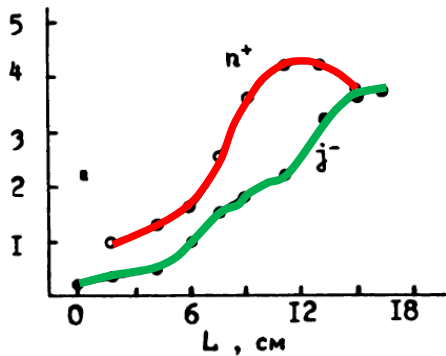
Discharge with auxiliary cathode



Uniform H- beam distribution along 80% of the cathode after cathode conditioning by the main and auxiliary discharge

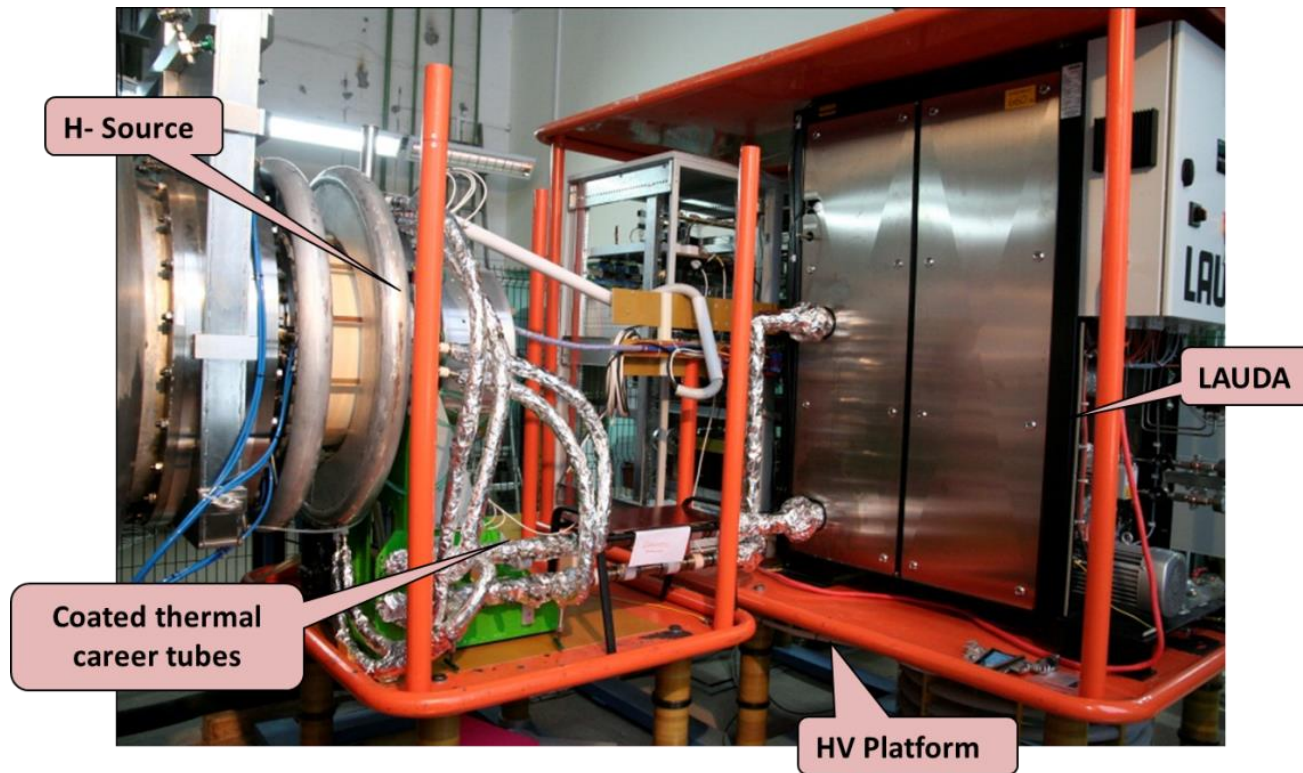
The similar Cs redistribution over the PG surface is produced in the RF sources due to Cs⁺ ions implantation

n^+ , j^- a.u.



Cs redistribution due to Cs⁺ ions shift in ExB direction
(Self-activation by discharge)

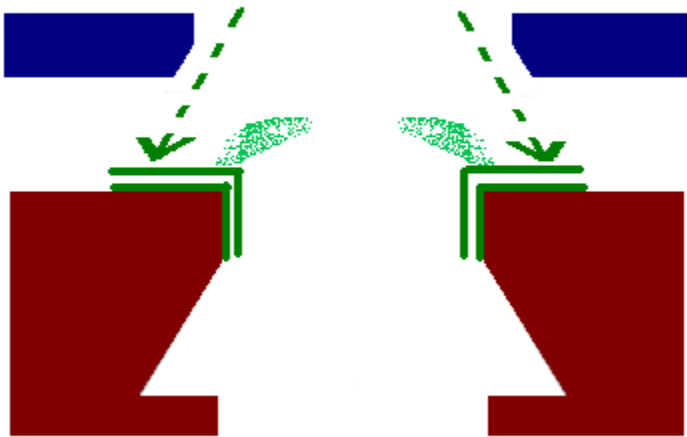
Thermal Stabilization of Electrodes



Thermal Stabilization System LAUDA at 120 kV platform

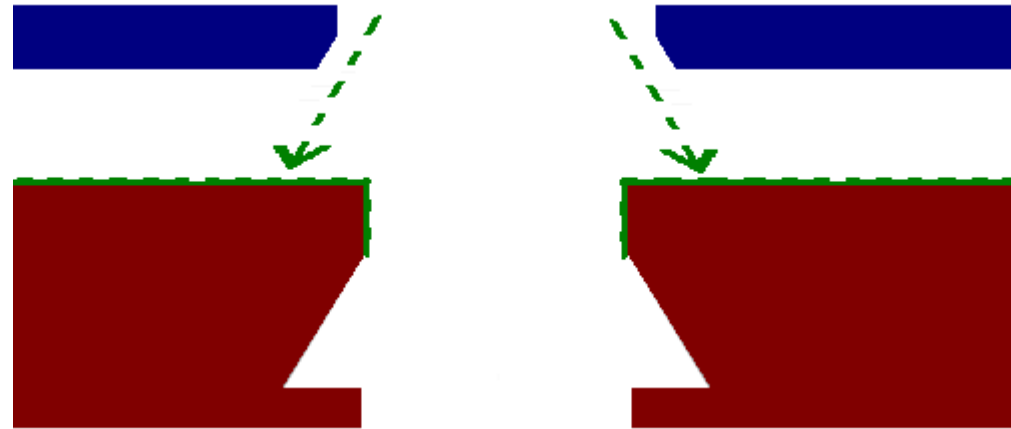
- **PG heating to 150 - 250°C temperature enhances H- yield**
- **Grids heating is provided by circulation of Heat Transfer Fluid and it is independent of discharge power**

Mechanism of HV holding improvement with Electrodes Heating



Cold Electrodes

Sputtering of the thick layers of accumulated cesium

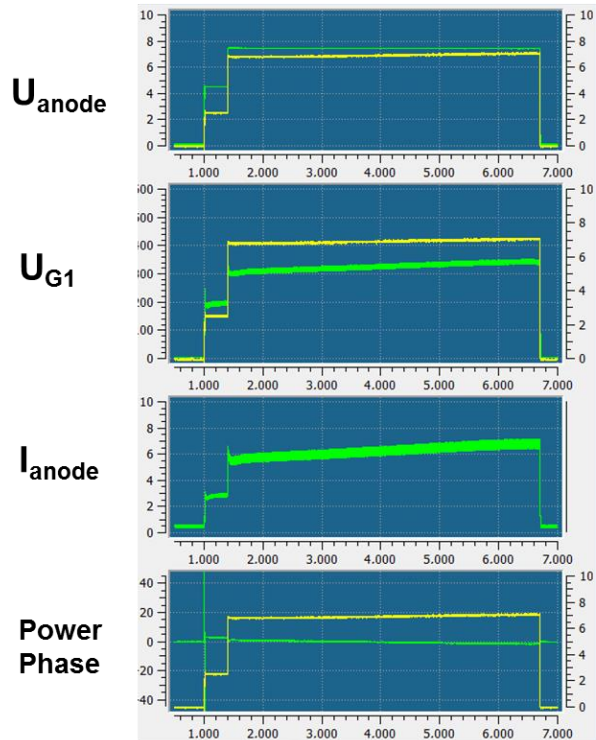


Hot electrodes

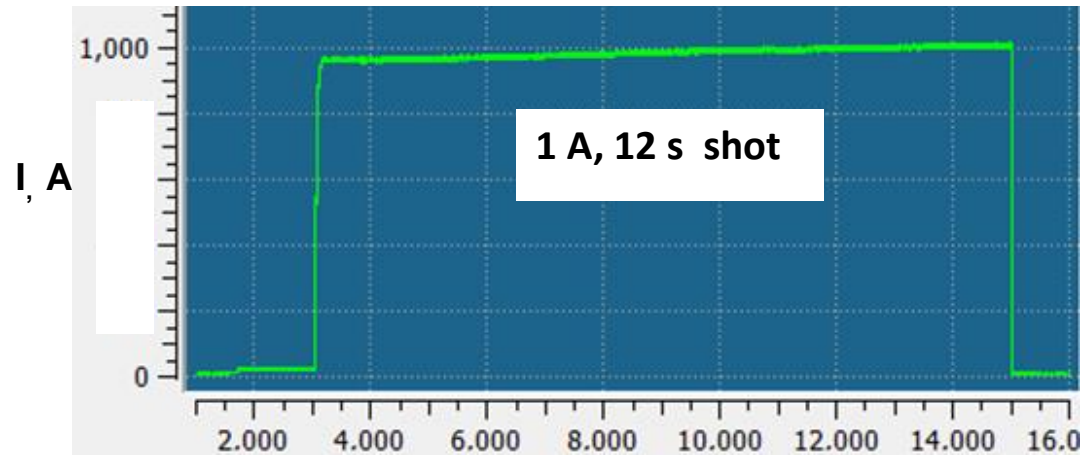
Exponential growth of Cs surface diffusion and thermal desorption with electrode temperature.
Easy Cs removal out of the electrode apertures edges.

No sputtering of the thick layers of accumulated cesium

Source operates stably and reliably



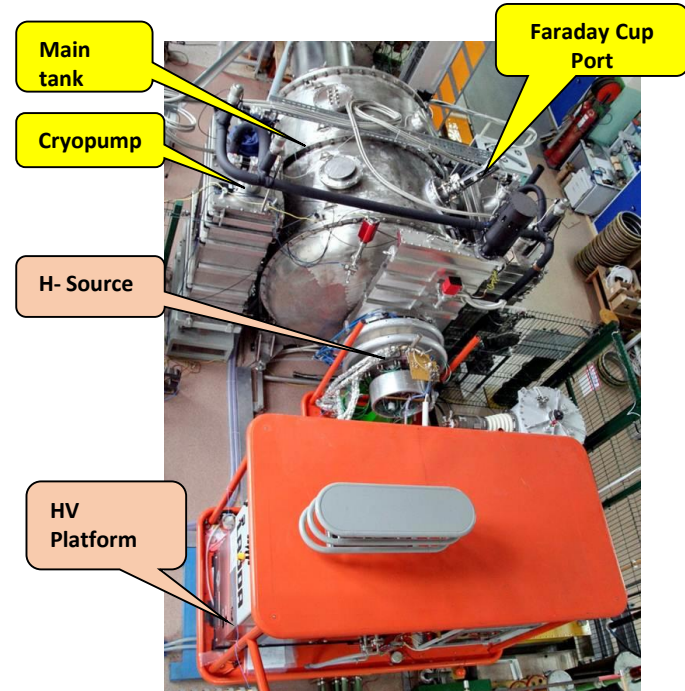
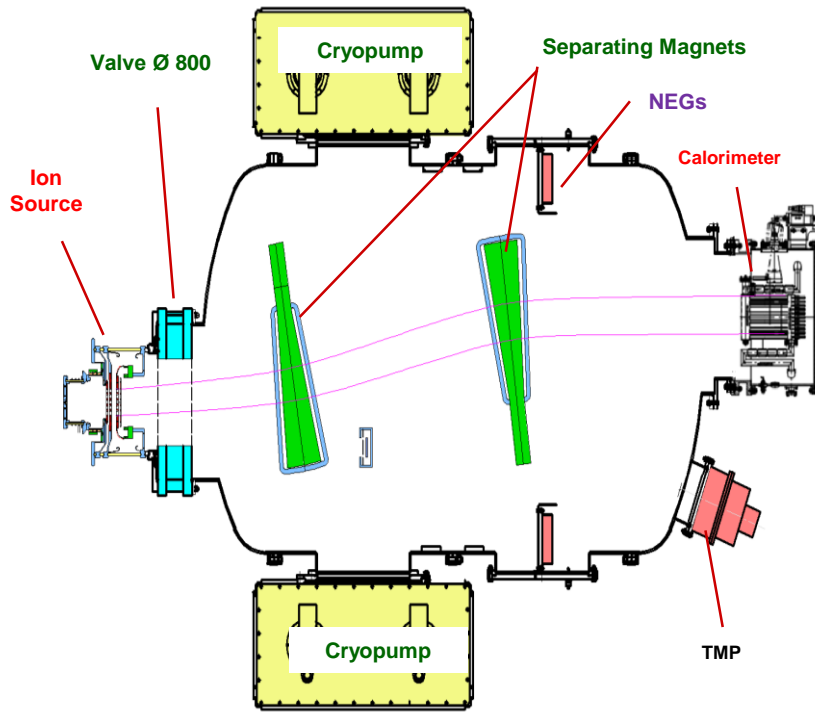
RF Driver - 5 s pulse



- H- ion beams with current $>1\text{A}$ and energy $\geq 110\text{ keV}$ are regularly produced.
- Power efficiency of H- ion production is 28 kW/A
- H- ion beam was transported through the LEBT to distance 3.5 m

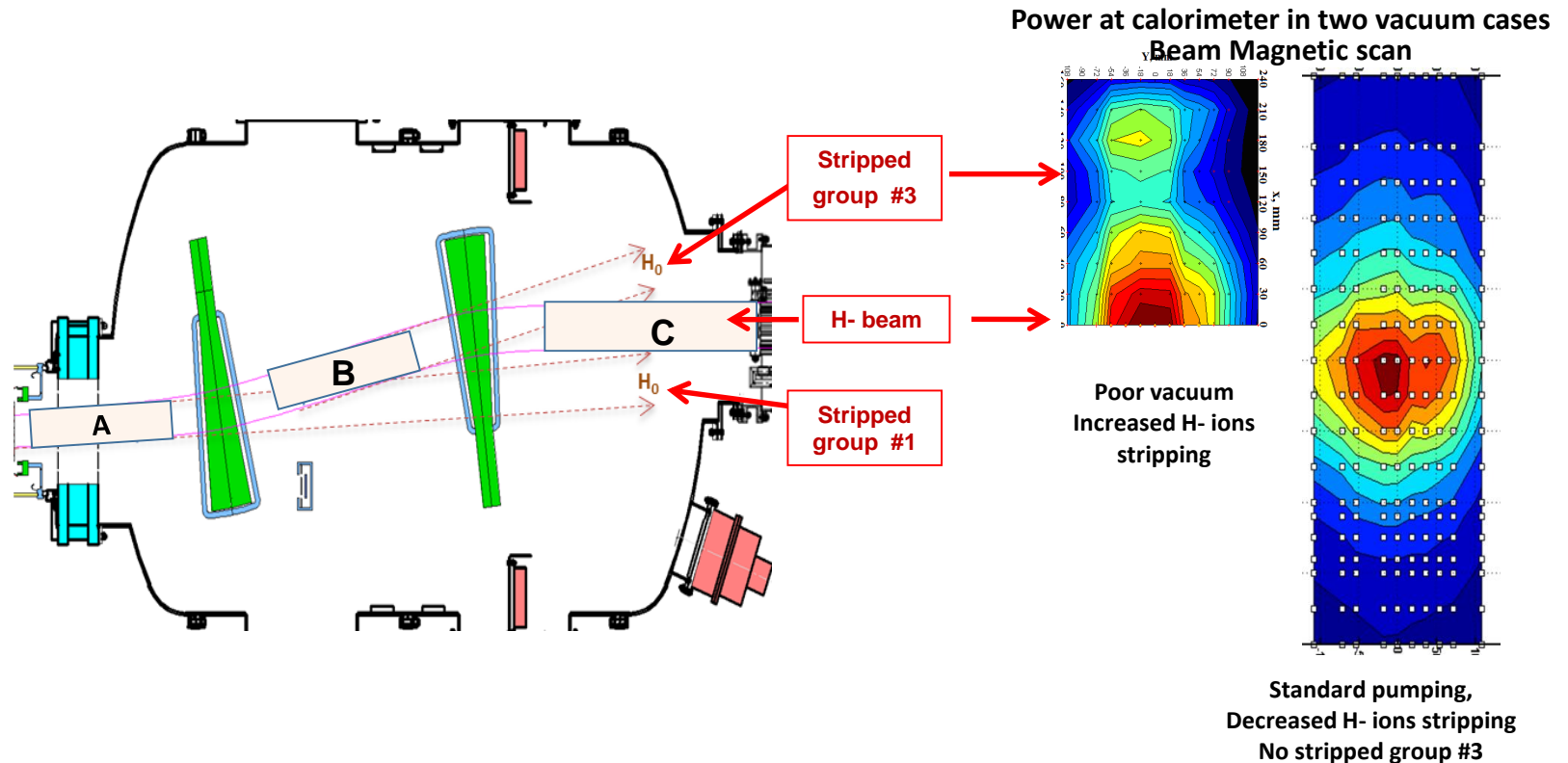
H- beam transport study

Will be reported in the next talk Thu09 of O.Sotnikov



- **Ion Source** is at 120 kV platform and attached to \varnothing 2.1 m x 3.1 m tank
- **Two cryopumps** (four cryocoolers) with hydrogen pumping $\sim 2 \cdot 10^5$ l/s.
- **Thermo-stabilization system** (70 kW) & auxiliary PSs are at 120 kV (1 MeV) platform.
- **Main PSs** are at basement floor

H- beam transport study

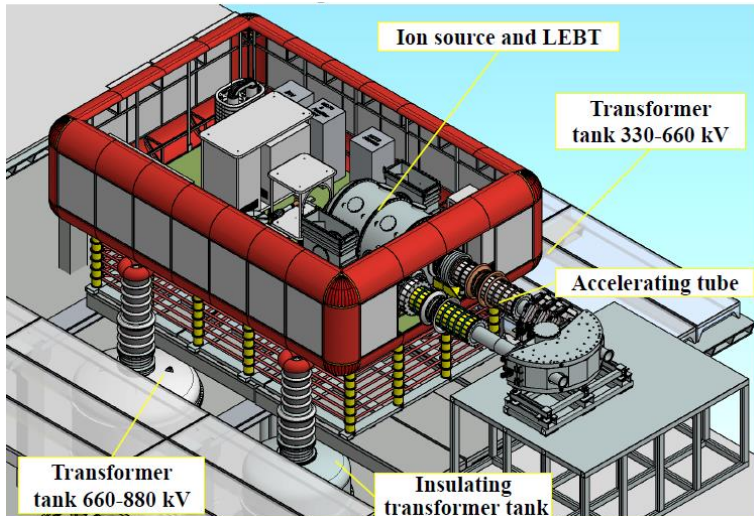


H- beam is well separated from the parasitic atoms, produced by NI stripping.

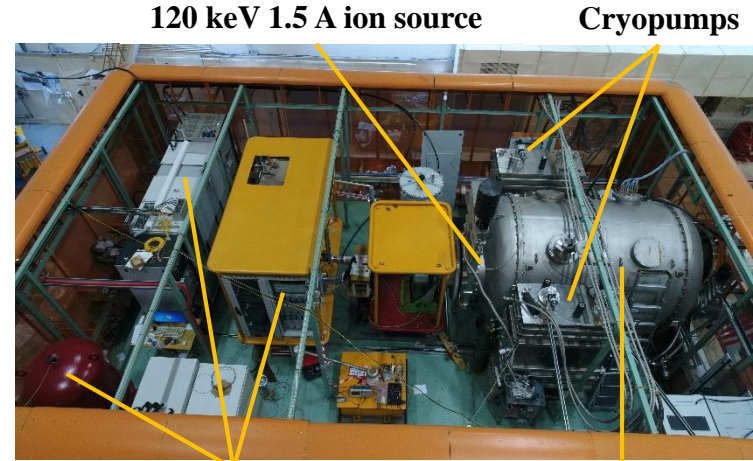
~ 80% of the H- beam with energy 93 keV , outgoing from the source were transported to the calorimeter window 30 x 30 cm

**The RF source was moved to the HV platform of the 1 MeV stand.
The transport study will be continued at full beam energy 120 KeV**

1 MV, 1.5 A Negative Ion Beam Stand



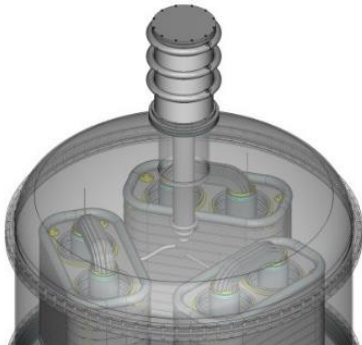
Design



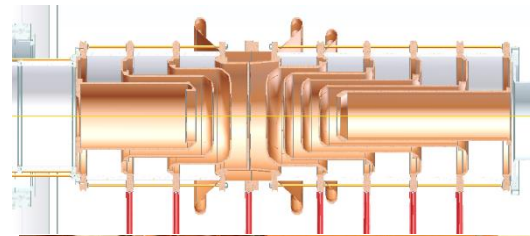
Source power supplies

LEBT tank

0,9 MV platform with NI source and LEBT

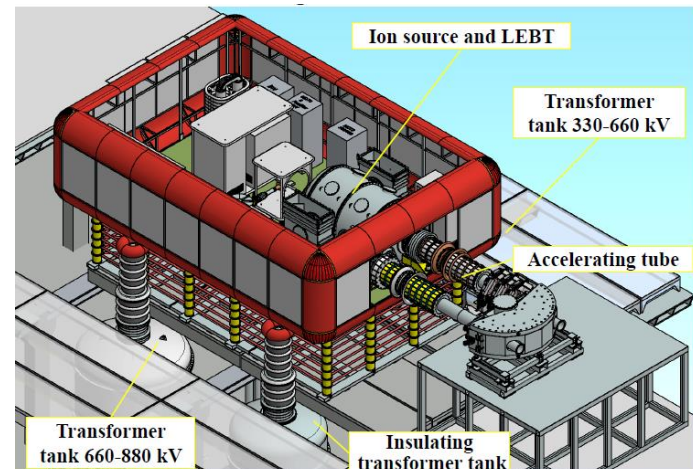
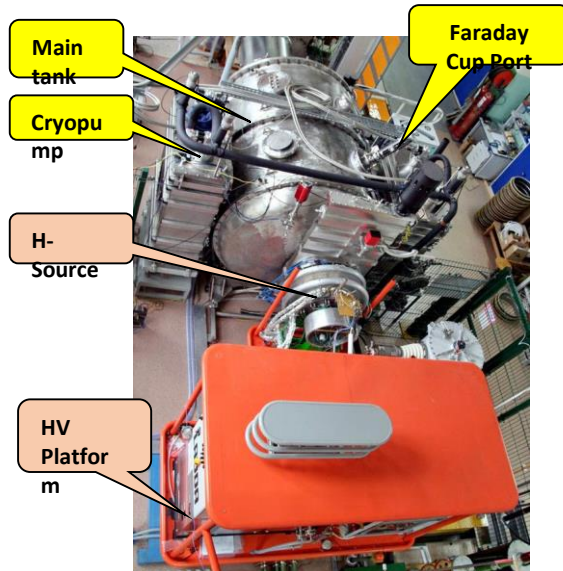
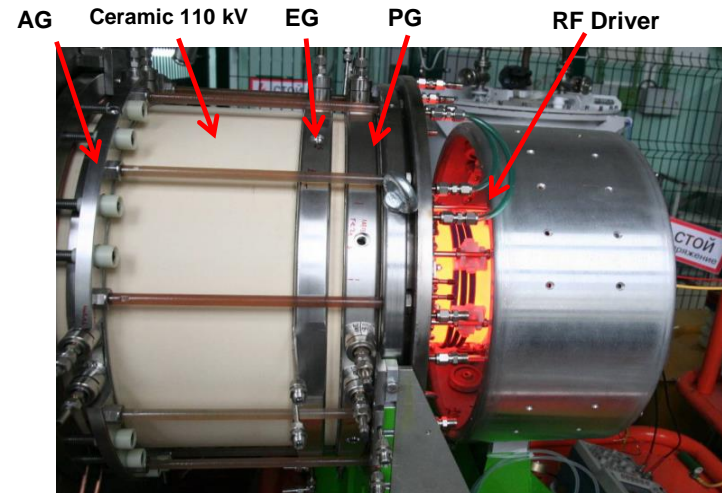
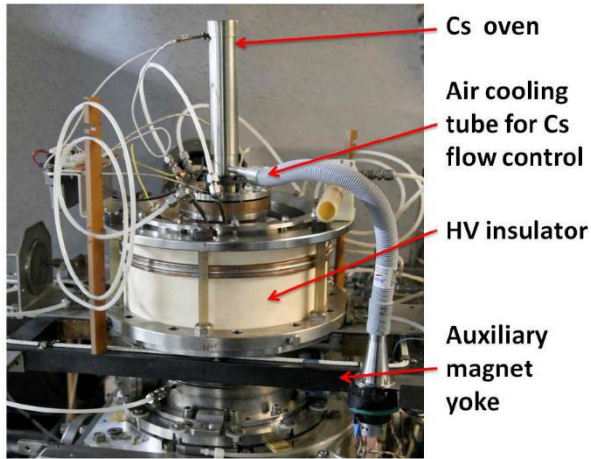


HV rectifier tanks and Bushing



Acceleration tube

You are welcome to visit the BINP NI Facilities



Thank You for attention